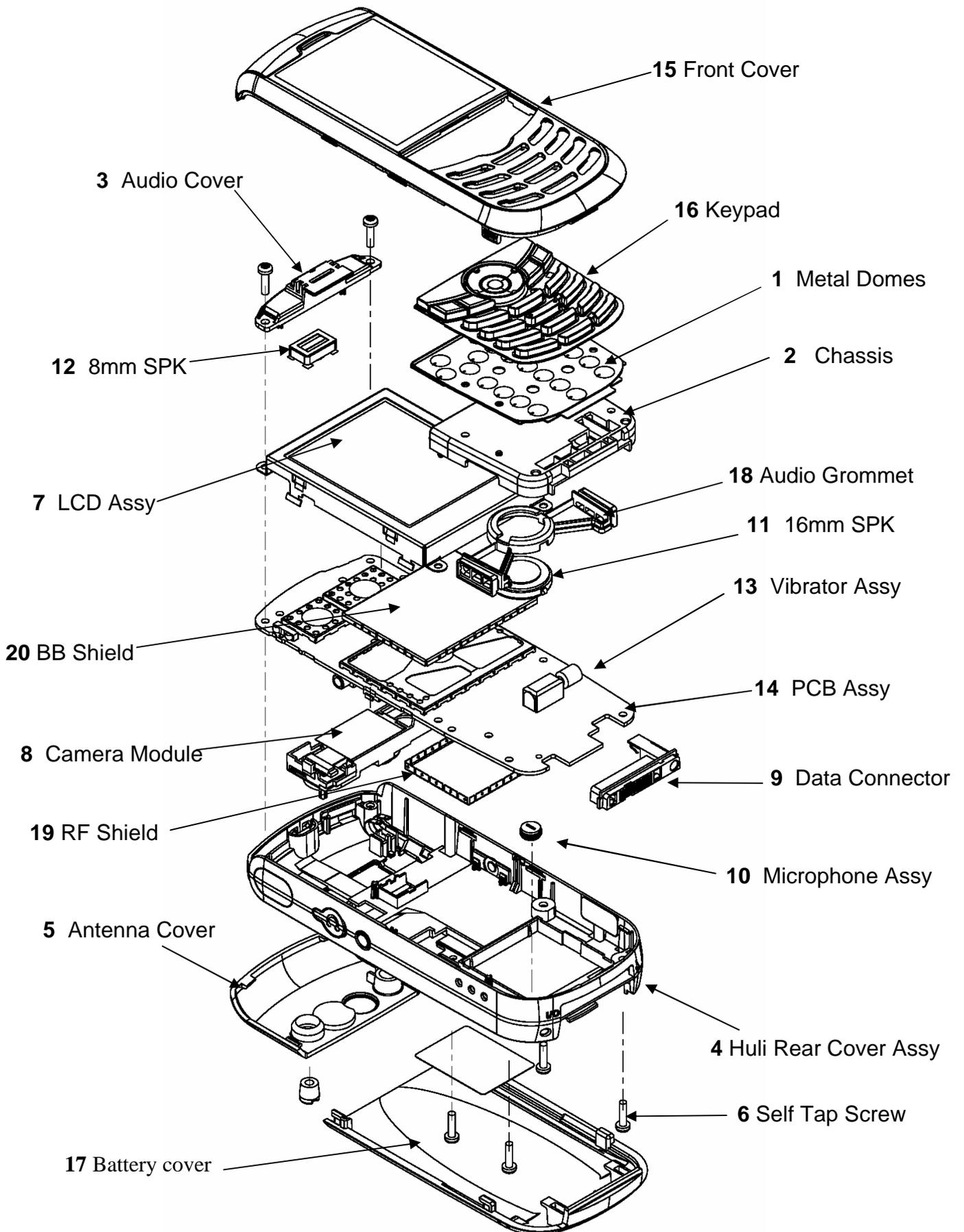


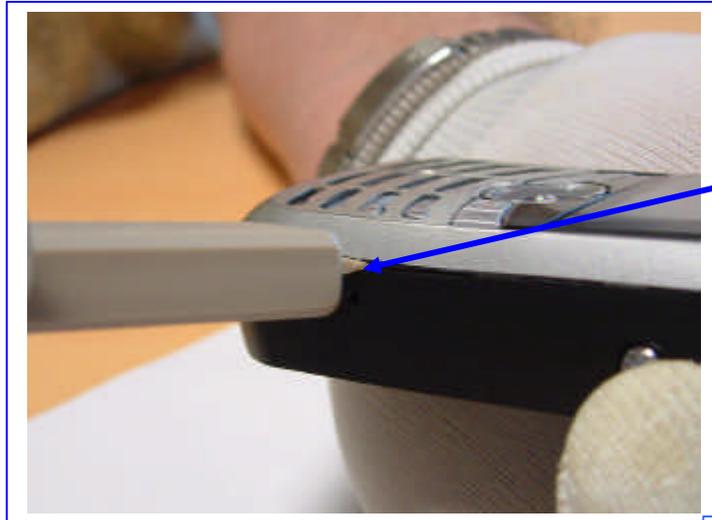
Mechanical Assembly Parts



5.5 Dis-Assembly Procedure

5.5a Front cover removal

Note: Before the Sendo X can be dis-assembled, the battery and battery cover must firstly be removed.



Insert opening tool between front/rear cover as shown.



Carefully ease the covers apart along the joint up to the top of the unit.

Continue to pry the left and right sides to working the tool further along the housing edge to release all the side locks.

Note:

To minimise damage to battery holder and front housing care must be taken not to damage the side locks/hooks/features on the battery holder.

Note:

When dis-assembling the product **great care** must be taken while opening the covers, as they can easily be damaged if not handled correctly. **Always ensure** the fixing locks/hooks/features are released correctly.

5.5a Front cover removal



With the side locks released, gently remove the front cover from the rear cover. Start to separate the covers from the bottom first as shown.

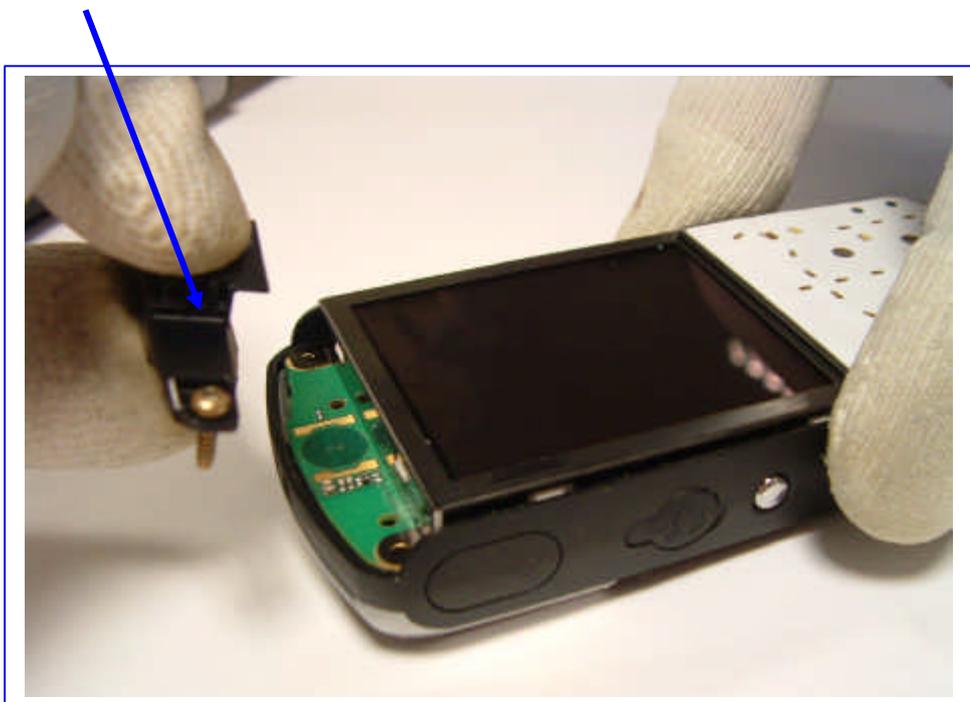


When separating the covers care must be taken when removing the LCD gasket from the LCD.

The keypad can now also be removed from the front cover.

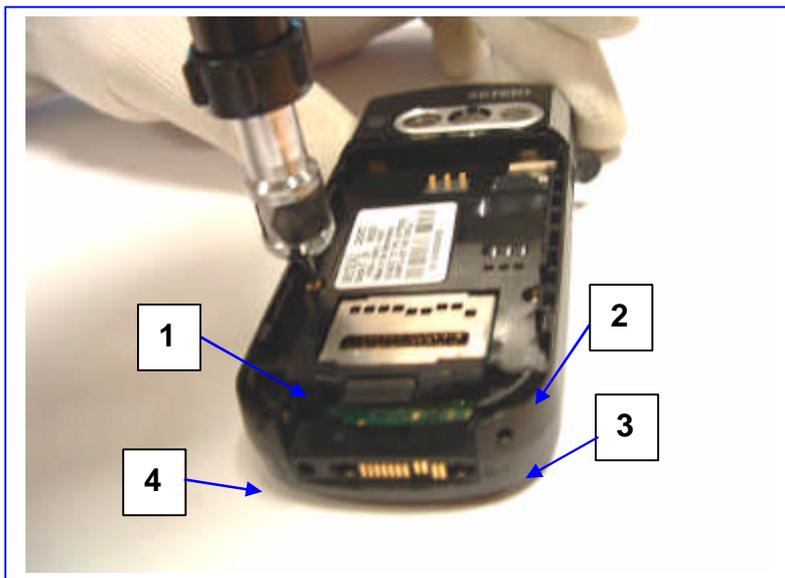
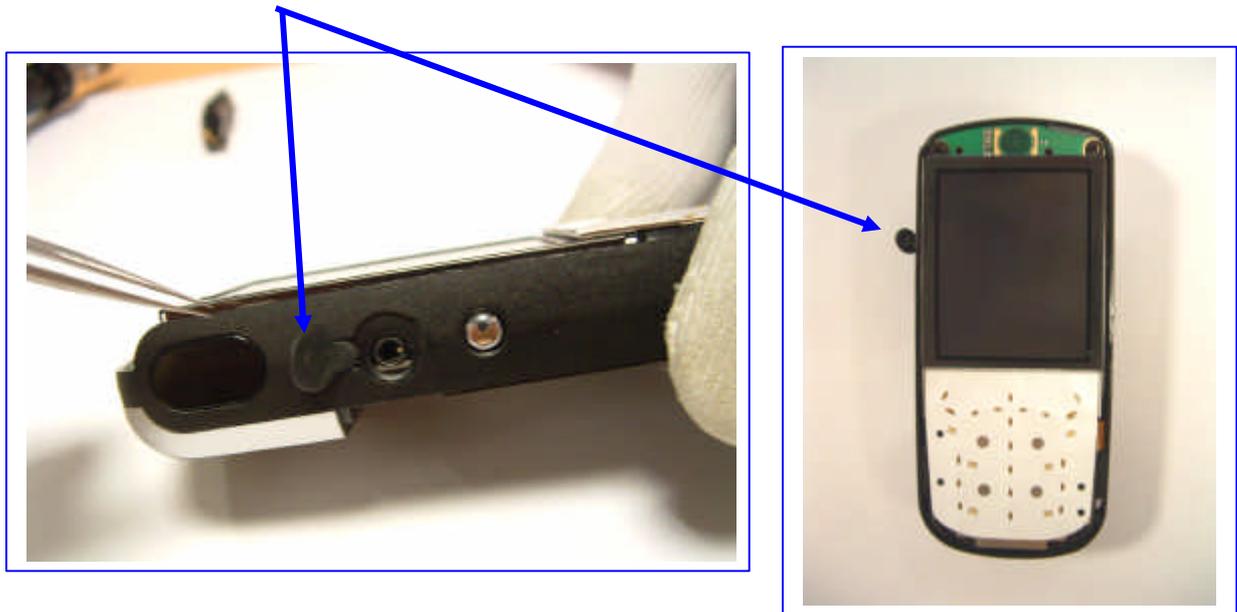


5.5b Audio Cover Removal



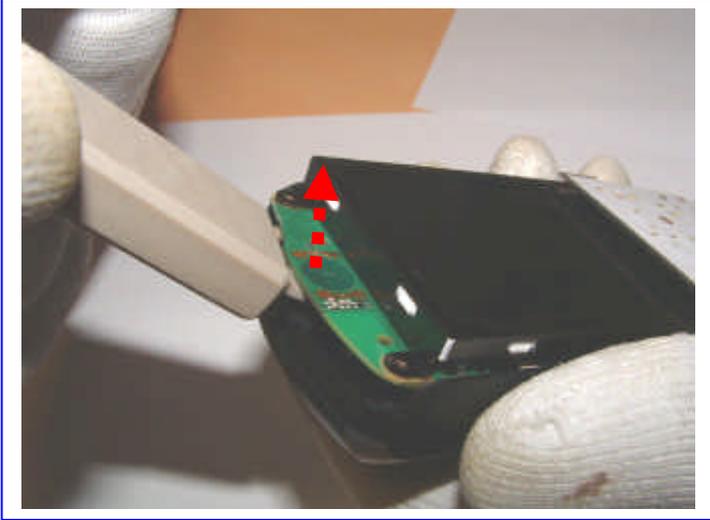
5.5c Removal of the PCB assembly from the rear cover.

Before the pcb assy can be removed from the rear cover the headset cover has to be unplugged as shown below.



Remove the four fixing screws from the rear cover.

5.5c Removal of the PCB assembly from the rear cover (cont'd).



Using the opening tool insert it in the location shown opposite and gently separate the pcb from the rear cover.
Then remove the pcb from the rear cover.